

By e-mail

16 December 2011

To: Selected applicants (invited by email individually)

Application for MPhil/PhD programme, The University of Hong Kong

Thank you for your application for admission to the MPhil/PhD programme of the Department of Electrical and Electronic Engineering, Faculty of Engineering, The University of Hong Kong.

I am pleased to inform you that you have been shortlisted for the programme. I would like to invite you to attend a test on English writing and an interview in Shenzhen. Details are as follows:

**a) Dates of Interview**

4 January, 2012

Time: from 2:00 pm

5 January, 2012

Time: from 11:00 am

6 January, 2012,

Time: from 9:00 am

Venue: 深圳香格里拉大酒店三樓會議室 (Meeting Concierge Room, 3/F., Shangri-La Hotel)

Please view the hotel details at:

<http://www.shangri-la.com/cn/property/shenzhen/shangrila>

**b) Written Test**

Date: 5 January, 2012

Time: 9:00 am – 10:20 am

Venue: 深圳香格里拉大酒店三樓深圳廳  
(Shenzhen Room, 3/F., Shangri-La Hotel)

A “word”file of this circular can be viewed at <http://www.eee.hku.hk/> later.

The Department is prepared to provide a cash sponsorship up to (RMB\$900) to help cover part of your travel/accommodation expenses for attending this interview. For this reimbursement, we need to have the photocopies of your photo-ID Card and the receipts/invoices of the expenses, such as hotel invoices and train/air tickets, etc. Therefore, please bring along with you the original copies and photocopies of these documents when showing up at interview in Shenzhen.

Please let us know if you will be able to attend the written test and the interview in Shenzhen by replying to this email to Ms. Julie (Email: [julie@eee.hku.hk](mailto:julie@eee.hku.hk)) before 31 December 2011.

We look forward to meeting you soon.

Professor P T Lai  
Chairman  
Departmental Research Postgraduate Committee

PTL/QC/jh: Email to invited candidate